2. (Amended) The semiconductor laser device of Claim 1, further comprising: a reflection coating positioned at a first end of said active layer and substantially perpendicular thereto; and

an antireflective coating positioned at a second end of said active layer opposing said first end and substantially perpendicular to said active layer,

wherein said reflection coating and said antireflective coating define a resonant cavity within said active region.

- 3. (Amended) The semiconductor laser device of Claim 2, wherein a length of said resonant cavity is at least 800μm.
- 4. (Amended) The semiconductor laser device of Claim 2, wherein a length of said resonant cavity is not greater than 3200μm.
- 5. (Amended) The semiconductor laser device of Claim 1, wherein said diffraction grating is formed substantially along an entire length of said active layer.
- 6. (Amended) The semiconductor laser device of Claim 5, wherein said diffraction grating comprises a plurality of grating elements having a constant pitch.
- 7. (Amended) The semiconductor laser device of Claim 5, wherein said diffraction grating comprises a chirped grating having a plurality of grating elements having fluctuating pitches.
- 8. (Amended) The semiconductor laser device of Claim 7, wherein said chirped grating is formed such that a fluctuation in the pitch of said plurality of grating elements is a random fluctuation.
- 9. (Amended) The semiconductor laser device of Claim 7, wherein said chirped grating is formed such that a fluctuation in the pitch of said plurality of grating elements is a periodic fluctuation.

10. (Amended) The semiconductor laser device of Claim 1, wherein said diffraction grating is a shortened diffraction grating formed along a portion of an entire length of said active layer.

11. (Amended) The semiconductor laser device of Claim 10, wherein said diffraction grating comprises a plurality of grating elements having a constant pitch.

12. (Amended) The semiconductor laser device of Claim 10, wherein said diffraction grating comprises a chirped grating having a plurality of grating elements having fluctuating pitches.

13. (Amended) The semiconductor laser device of Claim 12, wherein said chirped grating is formed such that a fluctuation in the pitch of said plurality of grating elements is a random fluctuation.

В

14. (Amended) The semiconductor laser device of Claim 12, wherein said chirped grating is formed such that a fluctuation in the pitch of said plurality of grating elements is a periodic fluctuation.

15. (Amended) The semiconductor laser device of Claim 10, further comprising: a reflection coating positioned at a first end of said active layer and substantially perpendicular thereto; and

an antireflective coating positioned at a second end of said active layer opposing said first end and substantially perpendicular to said active layer,

wherein said reflection coating and said antireflective coating define a resonant cavity within said active region.

16. (Amended) The semiconductor laser device of Claim 15, wherein said shortened diffraction grating is positioned along a portion of the active layer in the vicinity of said antireflective coating.

- 17. (Amended) The semiconductor laser device of Claim 16, wherein said antireflective coating has an ultra-low reflectivity of approximately 0.1% to 2%.
- 18. (Amended) The semiconductor laser device of Claim 16, wherein said antireflective coating has an ultra-low reflectivity of approximately 0.1% or less.
- 19. (Amended) The semiconductor laser device of Claim 16, wherein said reflection coating has a high reflectivity of at least 80%.
- 20. (Amended) The semiconductor laser device of Claim 16, wherein said shortened diffraction grating has a relatively low reflectivity.
- 21. (Amended) The semiconductor laser device of Claim 16, wherein said shortened diffraction grating has a coupling coefficient K\*Lg of approximately .3 or less.
- 22. (Amended) The semiconductor laser device of Claim 16, wherein said shortened diffraction grating has a coupling coefficient K\*Lg of approximately .1 or less.
- 23. (Amended) The semiconductor laser device of Claim 15, wherein said shortened diffraction grating is positioned along a portion of the active layer in the vicinity of said reflection coating.
- 24. (Amended) The semiconductor laser device of Claim 23, wherein said antireflective coating has a low reflectivity of approximately 1% to 5%.
- 25. (Amended) The semiconductor laser device of Claim 23, wherein said reflection coating has an ultra-low reflectivity of approximately 0.1% to 2%.
- 26. (Amended) The semiconductor laser device of Claim 23, wherein said reflection coating has an ultra-low reflectivity of approximately 0.1% or less.
- 27. (Amended) The semiconductor laser device of Claim 23, wherein said shortened diffraction grating has a relatively high reflectivity.

- 28. (Amended) The semiconductor laser device of Claim 23, wherein said shortened diffraction grating has a coupling coefficient K\*Lg of approximately 1 or more.
- 29. (Amended) The semiconductor laser device of Claim 23, wherein said shortened diffraction grating has a coupling coefficient K\*Lg of approximately 3 or more.
- 30. (Amended) The semiconductor laser device of Claim 15, wherein said shortened diffraction grating comprises a first shortened diffraction grating positioned along a portion of the active layer in the vicinity of said antireflective coating, and a second shortened diffraction grating positioned along a portion of the active layer in the vicinity of said reflection coating.
- 31. The semiconductor laser device of Claim 30, wherein said antireflective coating and said reflection coating have an ultra-low reflectivity of approximately 0.1% to 2%.
  - 32. (Amended) The semiconductor laser device of Claim 30, wherein said antireflective coating and said reflection coating have an ultra-low reflectivity of approximately 0.1% or less.
  - 33. (Amended) The semiconductor laser device of Claim 30, wherein said first shortened diffraction grating comprises a first shortened diffraction grating which has a relatively low reflectivity and second shortened diffraction grating which has a relatively high reflectivity.
  - 34. (Amended) The semiconductor laser device of Claim 30, wherein said first shortened diffraction grating comprises a first shortened diffraction grating having a coupling coefficient K\*Lg of approximately .3 or less.
  - 35. (Amended) The semiconductor laser device of Claim 30, wherein said first shortened diffraction grating comprises a first shortened diffraction grating having a coupling coefficient K\*Lg of approximately 1 or more.